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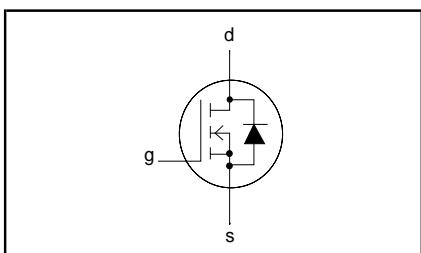
PSMN015-100B; PSMN015-100P N-channel TrenchMOSTM transistor

Product specification

August 1999

SiliconMAXN-channel TrenchMOSTM transistor**PSMN015-100B; PSMN015-100P****FEATURES**

- 'Trench' technology
- Very low on-state resistance
- Fast switching
- Low thermal resistance

SYMBOL**QUICK REFERENCE DATA**

$$V_{DSS} = 100 \text{ V}$$

$$I_D = 75 \text{ A}$$

$$R_{DS(ON)} \leq 15 \text{ m}\Omega$$

GENERAL DESCRIPTION

SiliconMAX products use the latest Philips Trench technology to achieve the lowest possible on-state resistance in each package at each voltage rating.

Applications:-

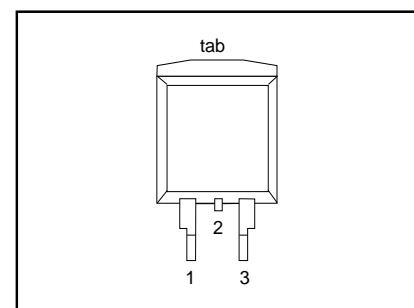
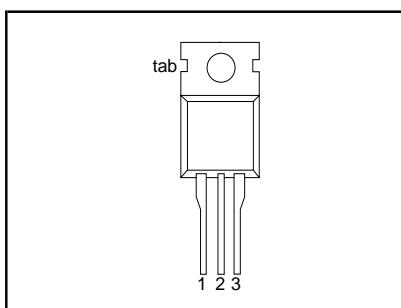
- d.c. to d.c. converters
- switched mode power supplies

The PSMN015-100P is supplied in the SOT78 (TO220AB) conventional leaded package.

The PSMN015-100B is supplied in the SOT404 surface mounting package.

PINNING**SOT78 (TO220AB)****SOT404 (D²PAK)**

PIN	DESCRIPTION
1	gate
2	drain ¹
3	source
tab	drain

**LIMITING VALUES**

Limiting values in accordance with the Absolute Maximum System (IEC 134)

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V_{DSS}	Drain-source voltage	$T_j = 25^\circ\text{C}$ to 175°C	-	100	V
V_{DGR}	Drain-gate voltage	$T_j = 25^\circ\text{C}$ to 175°C ; $R_{GS} = 20 \text{ k}\Omega$	-	100	V
V_{GS}	Gate-source voltage		-	± 20	V
I_D	Continuous drain current	$T_{mb} = 25^\circ\text{C}$	-	75 ²	A
I_{DM}	Pulsed drain current	$T_{mb} = 100^\circ\text{C}$	-	53	A
P_D	Total power dissipation	$T_{mb} = 25^\circ\text{C}$	-	240	A
T_j, T_{stg}	Operating junction and storage temperature	$T_{mb} = 25^\circ\text{C}$	-	230	W
			-55	175	°C

¹ It is not possible to make connection to pin:2 of the SOT404 package

² Maximum continuous current limited by package

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AVALANCHE ENERGY LIMITING VALUES

Limiting values in accordance with the Absolute Maximum System (IEC 134)

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
E _{AS}	Non-repetitive avalanche energy	Unclamped inductive load, I _{AS} = 74 A; t _p = 100 µs; T _j prior to avalanche = 25°C; V _{DD} ≤ 50 V; R _{GS} = 50 Ω; V _{GS} = 10 V; refer to fig:15	-	481	mJ
I _{AS}	Non-repetitive avalanche current		-	75	A

THERMAL RESISTANCES

SYMBOL	PARAMETER	CONDITIONS	TYP.	MAX.	UNIT
R _{th j-mb}	Thermal resistance junction to mounting base		-	0.65	K/W
R _{th j-a}	Thermal resistance junction to ambient	SOT78 package, in free air SOT404 package, pcb mounted, minimum footprint	60 50	- -	K/W K/W

ELECTRICAL CHARACTERISTICST_j = 25°C unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V _{(BR)DSS}	Drain-source breakdown voltage	V _{GS} = 0 V; I _D = 0.25 mA;	100	-	-	V
V _{GS(TO)}	Gate threshold voltage	V _{DS} = V _{GS} ; I _D = 1 mA	89 2.0	- 3.0	- 4.0	V
R _{DS(ON)}	Drain-source on-state resistance	V _{GS} = 10 V; I _D = 25 A	1.0	-	-	V
I _{GSS}	Gate source leakage current	V _{GS} = ±10 V; V _{DS} = 0 V	-	12	15	mΩ
I _{DSS}	Zero gate voltage drain current	V _{DS} = 100 V; V _{GS} = 0 V;	-	-	41	mΩ
			-	2	100	nA
			-	0.05	10	µA
			-	-	500	µA
Q _{g(tot)}	Total gate charge	I _D = 75 A; V _{DD} = 80 V; V _{GS} = 10 V	-	109	-	nC
Q _{gs}	Gate-source charge		-	20	-	nC
Q _{gd}	Gate-drain (Miller) charge		-	50	-	nC
t _{d on}	Turn-on delay time	V _{DD} = 50 V; R _D = 1.8 Ω;	-	30	-	ns
t _r	Turn-on rise time	V _{GS} = 10 V; R _G = 5.6 Ω	-	80	-	ns
t _{d off}	Turn-off delay time	Resistive load	-	150	-	ns
t _f	Turn-off fall time		-	95	-	ns
L _d	Internal drain inductance	Measured from tab to centre of die	-	3.5	-	nH
L _d	Internal drain inductance	Measured from drain lead to centre of die	-	4.5	-	nH
L _s	Internal source inductance	Measured from source lead to source bond pad	-	7.5	-	nH
C _{iss}	Input capacitance	V _{GS} = 0 V; V _{DS} = 25 V; f = 1 MHz	-	4720	-	pF
C _{oss}	Output capacitance		-	650	-	pF
C _{rss}	Feedback capacitance		-	380	-	pF

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REVERSE DIODE LIMITING VALUES AND CHARACTERISTICS $T_j = 25^\circ\text{C}$ unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
I_s	Continuous source current (body diode)		-	-	75	A
I_{SM}	Pulsed source current (body diode)		-	-	240	A
V_{SD}	Diode forward voltage	$I_F = 25 \text{ A}; V_{GS} = 0 \text{ V}$	-	0.8	1.2	V
t_{rr} Q_{rr}	Reverse recovery time Reverse recovery charge	$I_F = 20 \text{ A}; -dI_F/dt = 100 \text{ A}/\mu\text{s};$ $V_{GS} = 0 \text{ V}; V_R = 30 \text{ V}$	-	90 0.3	-	ns μC

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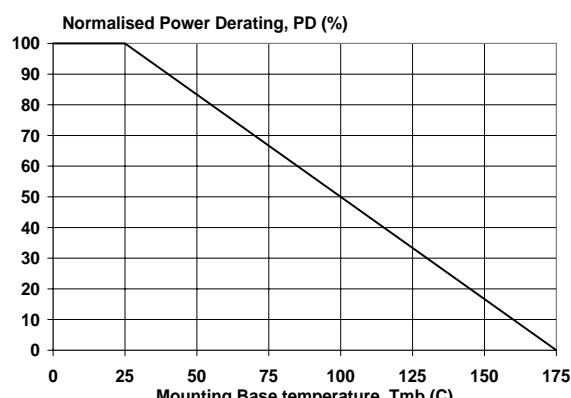


Fig.1. Normalised power dissipation.
 $PD\% = 100 \cdot P_D / P_{D\ 25\ ^\circ C} = f(T_{mb})$

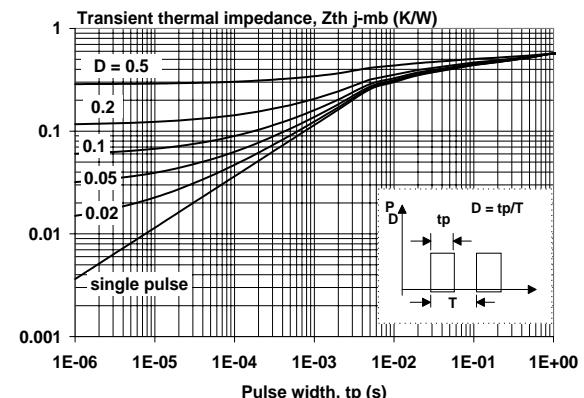


Fig.4. Transient thermal impedance.
 $Z_{th\ j\cdot mb} = f(t_p)$; parameter $D = t_p/T$

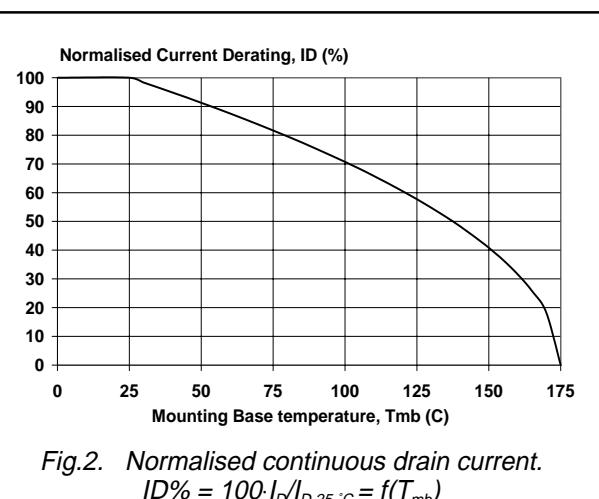


Fig.2. Normalised continuous drain current.
 $ID\% = 100 \cdot I_D / I_{D\ 25\ ^\circ C} = f(T_{mb})$

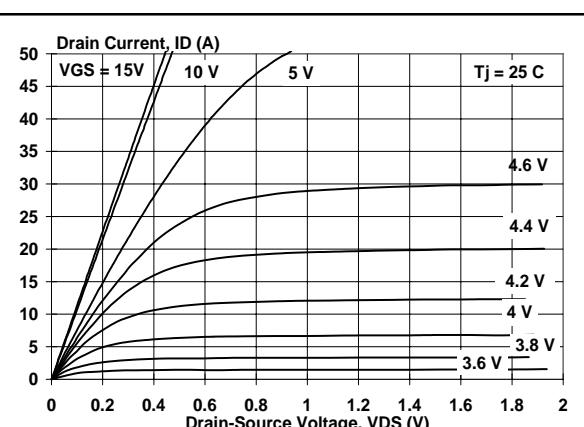


Fig.5. Typical output characteristics, $T_j = 25\ ^\circ C$.
 $I_D = f(V_{DS})$; parameter V_{GS}

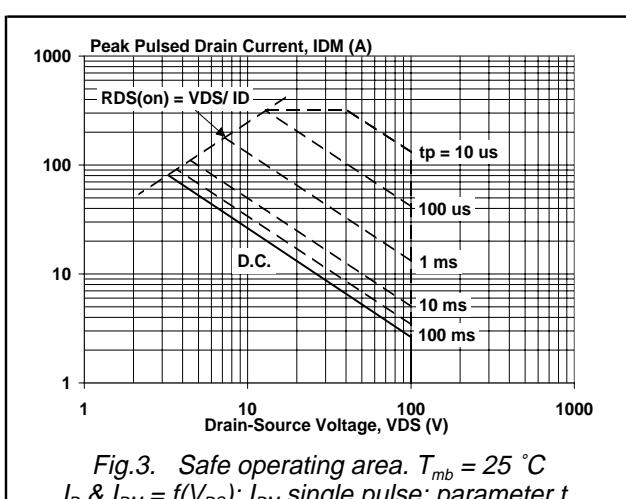


Fig.3. Safe operating area. $T_{mb} = 25\ ^\circ C$
 I_D & $I_{DM} = f(V_{DS})$; I_{DM} single pulse; parameter t_p

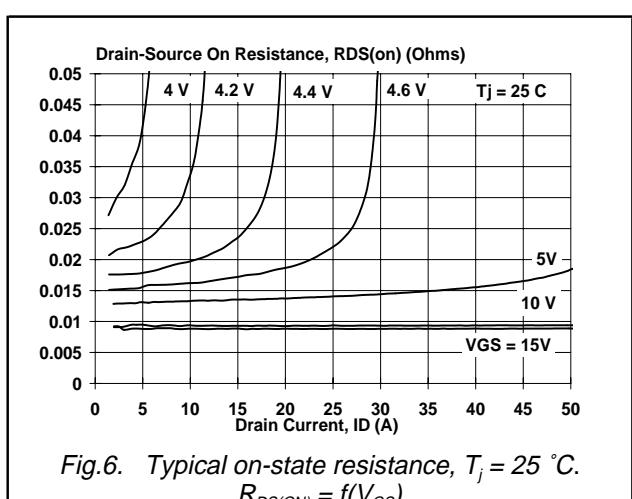


Fig.6. Typical on-state resistance, $T_j = 25\ ^\circ C$.
 $R_{DS(ON)} = f(V_{GS})$

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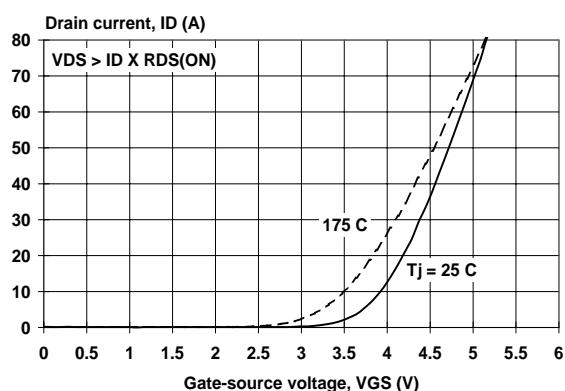


Fig.7. Typical transfer characteristics.
 $I_D = f(V_{GS})$; parameter T_j

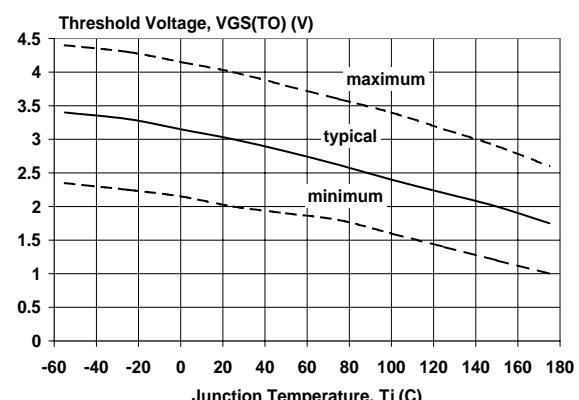


Fig.10. Gate threshold voltage.
 $V_{GS(TO)} = f(T_j)$; conditions: $I_D = 1\text{ mA}$; $V_{DS} = V_{GS}$

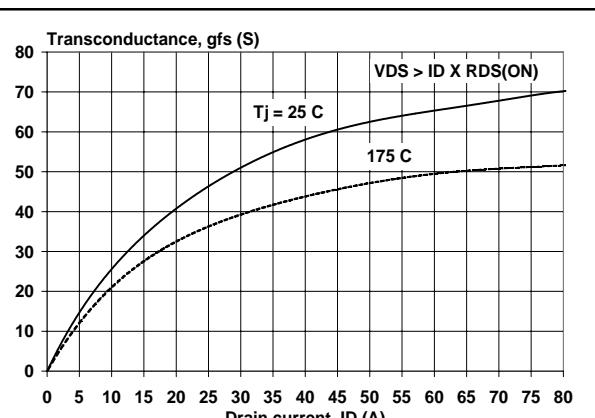


Fig.8. Typical transconductance, $T_j = 25^\circ\text{C}$.
 $g_{fs} = f(I_D)$

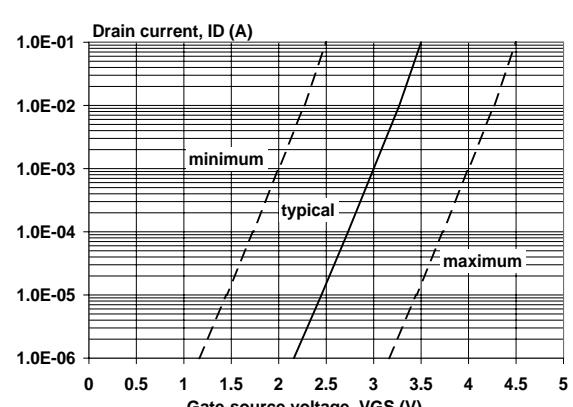


Fig.11. Sub-threshold drain current.
 $I_D = f(V_{GS})$; $T_j = 25^\circ\text{C}$

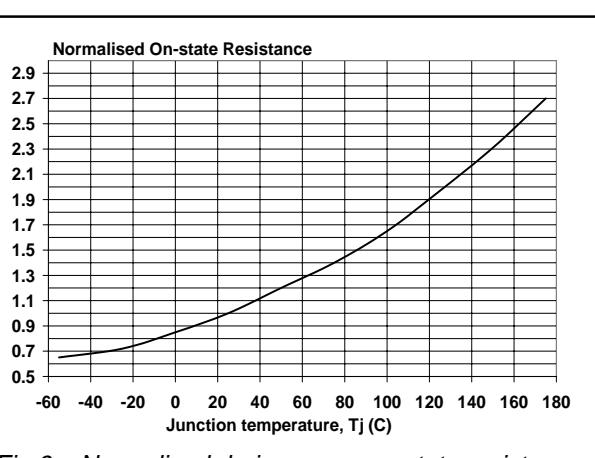


Fig.9. Normalised drain-source on-state resistance.
 $R_{DS(ON)}/R_{DS(ON)25^\circ\text{C}} = f(T_j)$

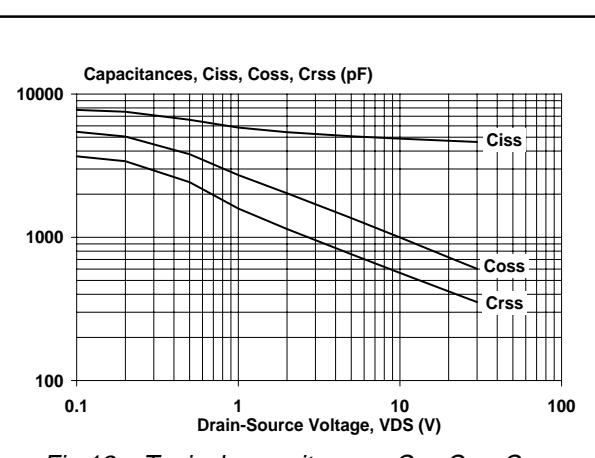


Fig.12. Typical capacitances, C_{iss} , C_{oss} , C_{rss} .
 $C = f(V_{DS})$; conditions: $V_{GS} = 0\text{ V}$; $f = 1\text{ MHz}$

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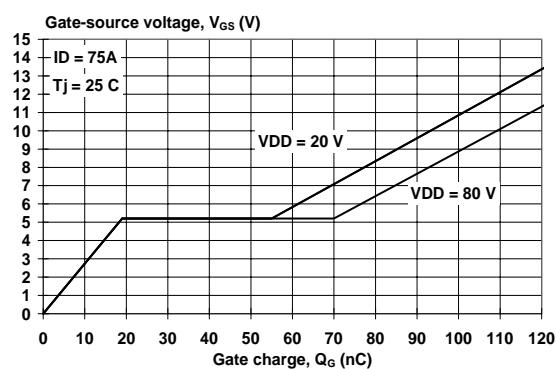


Fig.13. Typical turn-on gate-charge characteristics
 $V_{GS} = f(Q_G)$

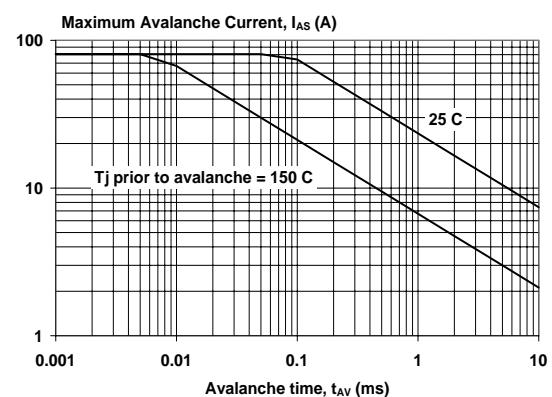


Fig.15. Maximum permissible non-repetitive avalanche current (I_{AV}) versus avalanche time (t_{AV}); unclamped inductive load

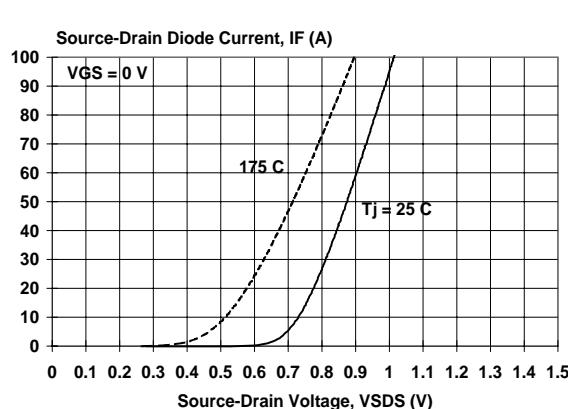


Fig.14. Typical reverse diode current.
 $I_F = f(V_{SDS})$; conditions: $V_{GS} = 0 V$; parameter T_j

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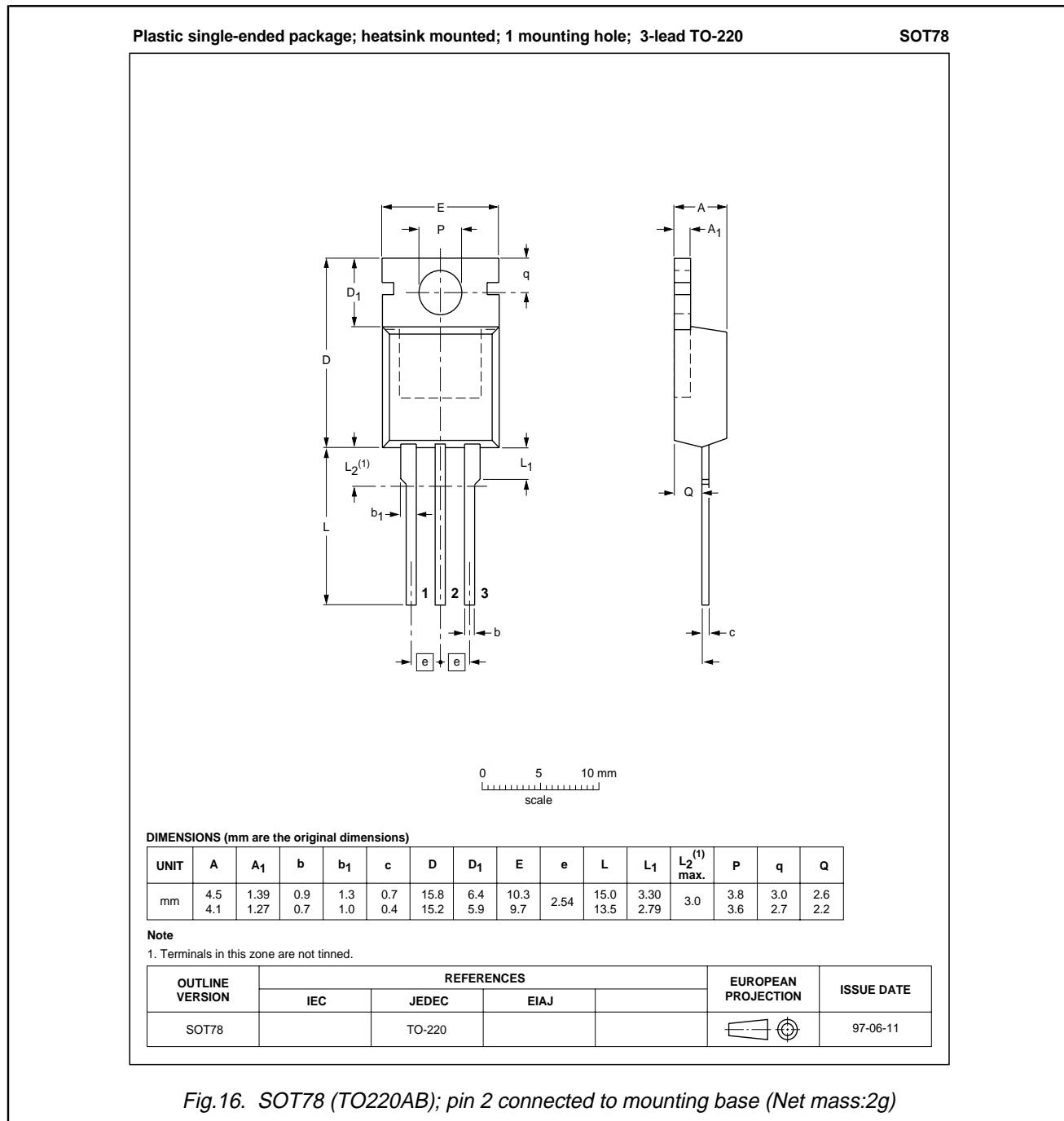
MECHANICAL DATA

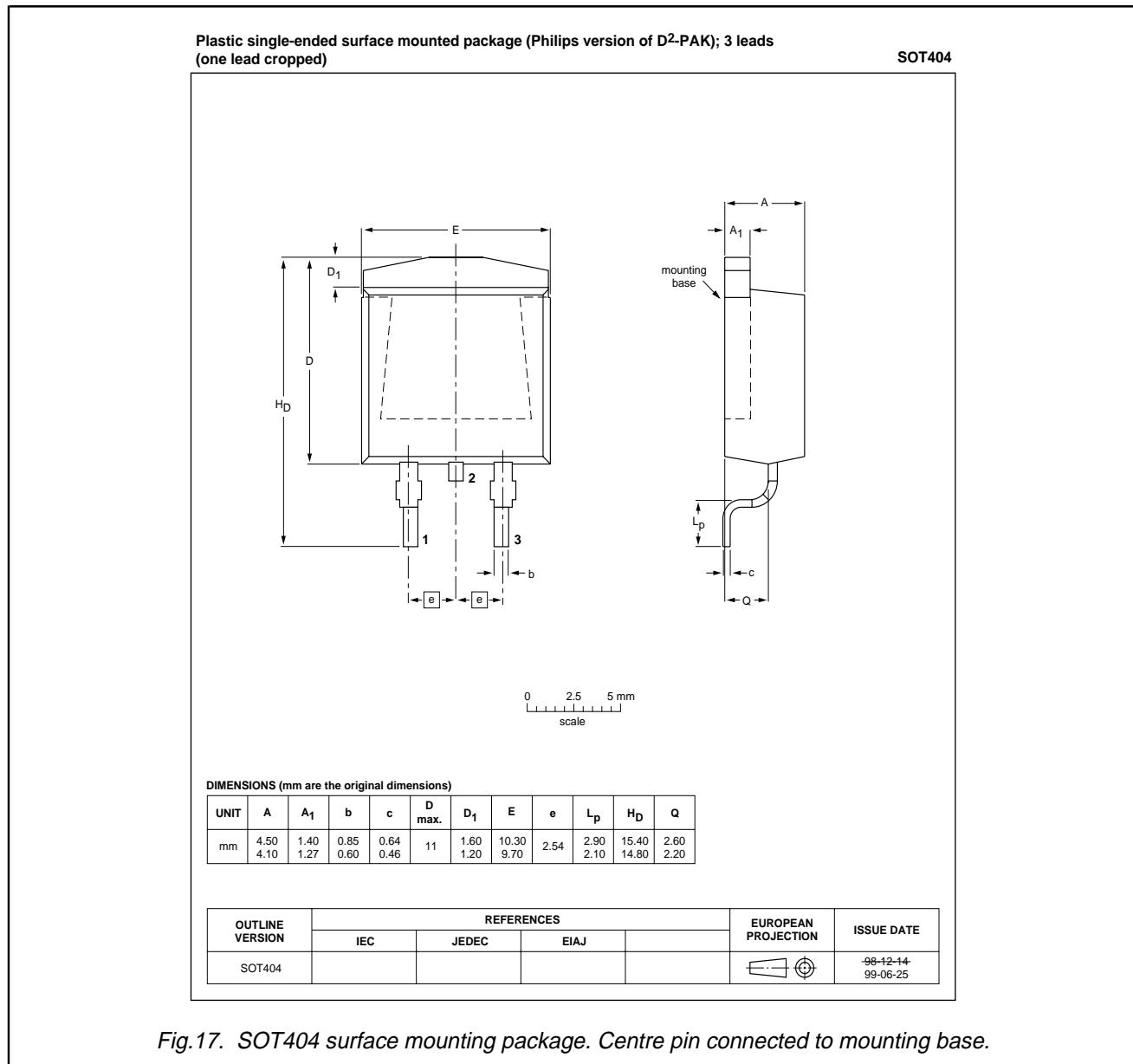
Fig.16. SOT78 (TO220AB); pin 2 connected to mounting base (Net mass:2g)

Notes

- This product is supplied in anti-static packaging. The gate-source input must be protected against static discharge during transport or handling.
- Refer to mounting instructions for SOT78 (TO220AB) package.
- Epoxy meets UL94 V0 at 1/8".

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MECHANICAL DATA**Notes**

1. This product is supplied in anti-static packaging. The gate-source input must be protected against static discharge during transport or handling.
2. Refer to SMD Footprint Design and Soldering Guidelines, Data Handbook SC18.
3. Epoxy meets UL94 V0 at 1/8".

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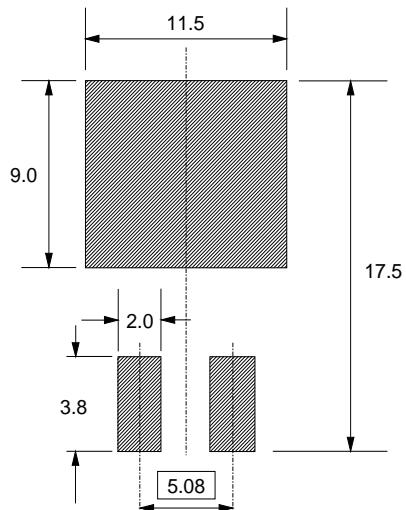
MOUNTING INSTRUCTIONS*Dimensions in mm*

Fig.18. SOT404 : soldering pattern for surface mounting.

DEFINITIONS

Data sheet status	
Objective specification	This data sheet contains target or goal specifications for product development.
Preliminary specification	This data sheet contains preliminary data; supplementary data may be published later.
Product specification	This data sheet contains final product specifications.
Limiting values	
Limiting values are given in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of this specification is not implied. Exposure to limiting values for extended periods may affect device reliability.	
Application information	
Where application information is given, it is advisory and does not form part of the specification.	
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N-channel TrenchMOS^(TM) transistor

PSMN015-100B; PSMN015-100P

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